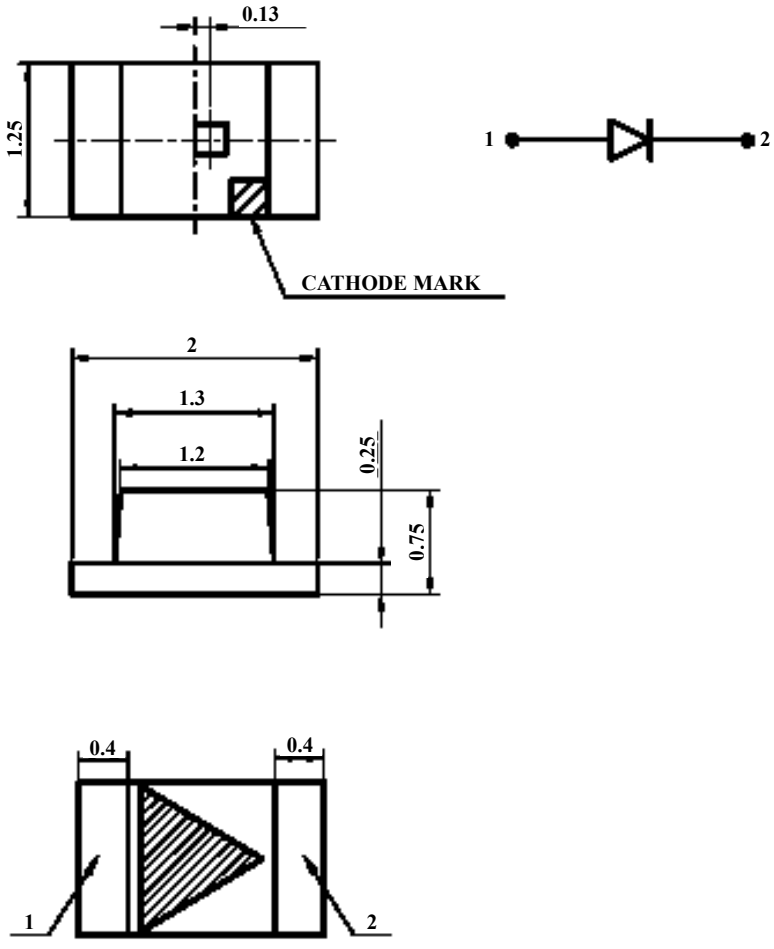
PRODUCT SPECIFICATION

DATE: 05/20/2004

cosmo ELECTRONICS CORPORATION	SMD LED : **KL-170YGX**	NO. 61L20001	REV. 1
		SHEET 1 OF 9	

UNIT:MM

TOLERANCE: ±0.15



Part No.	Emitting Color	Material	Lens Type	Iv (I_F=20mA)		Viewing Angle 2θ 1/2
				MIN (mcd)	TYP (mcd)	
KL-170YGX	Green	GaP	Water Clear	5	12	120°

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		SHEET 2 OF 9	

Absolute maximum ratings (TA=25℃)		G Green (GaP)	Unit
Reverse voltage	V_R	5	V
Forward current	I_F	25	mA
Forward current(Peak) 1/10 Duty Cycle,0.1ms Pulse Width	I_{FP}	100	mA
Power dissipation	P_d	40	mW
LED LAMPS:			
Operating temperature	T_{OP}	-40~+85	℃
Storage temperature	T_{ST}	-40~+85	℃
LED DISPLAYS:			
Operating temperature	T_A	-40~+85	℃
Storage temperature	T_{STG}	-40~+85	℃

Operating characteristics (TA=25℃)		G Green (GaP)	Unit
Forward voltage(typ.) I_F=20mA	V_F	2.2	V
Forward voltage(max.) I_F=20mA	V_F	2.6	V
Reverse current(max.) V_R=5V	I_R	10	uA
Wavelength at dominant emission(typ.) I_F=20mA	λ_D	570	nm
Wavelength at peak emission(typ.) I_F=20mA	λ_P	568	nm
Spectral line half-width I_F=20mA	$\Delta\lambda$	30	nm
Capacitance V_F=0V,f=1MHz	C	45	pF

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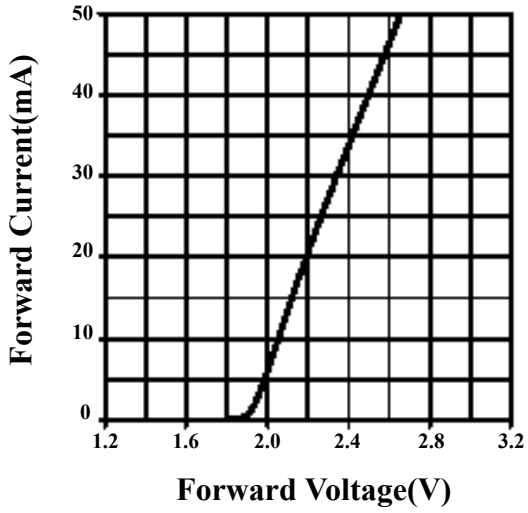
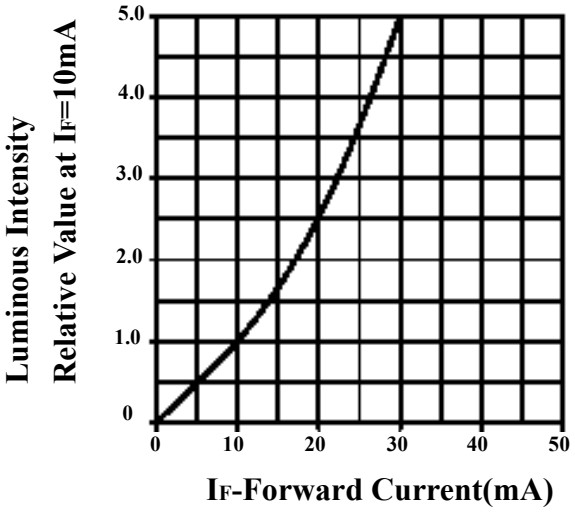
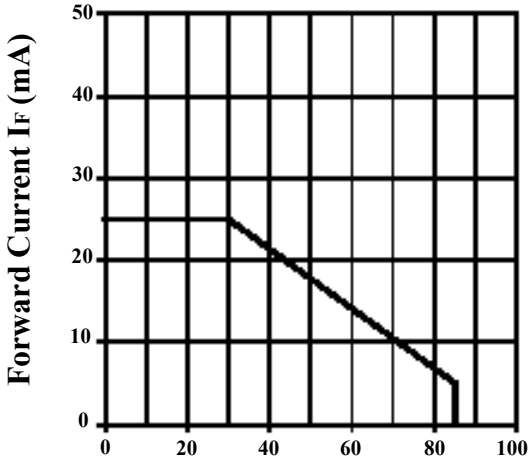
		SHEET 3 OF 9	



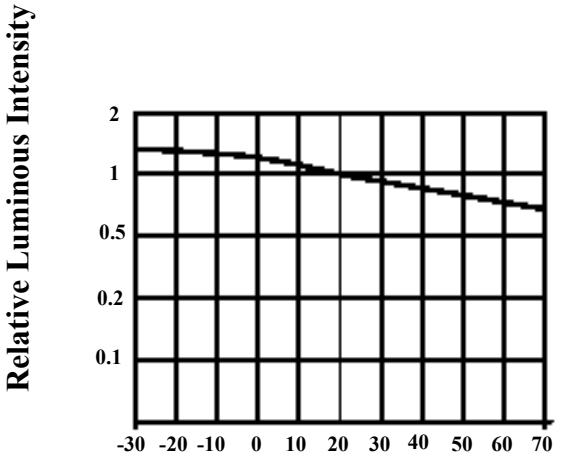
Forward Current Vs.
Forward Voltage



Luminous Intensity Vs.
Forward Current



Forward Current
Derating Curve

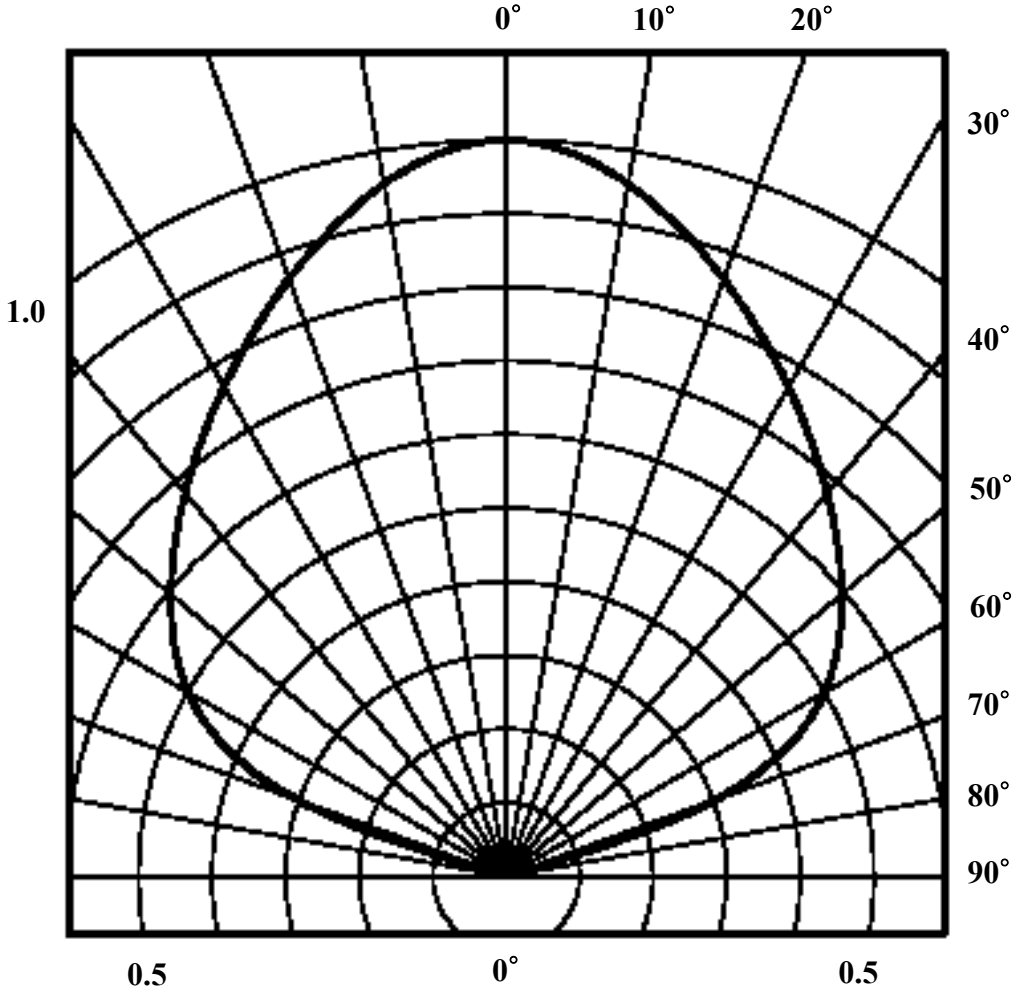


Luminous Intensity Vs.
Ambient Temperature

PRODUCT SPECIFICATION

DATE: 05/20/2004

cosmo ELECTRONICS CORPORATION	SMD LED : KL-170YGX	NO. 61L20001	REV. 1
		SHEET 4 OF 9	



View Angle 2 θ1/2=120°

PRODUCT SPECIFICATION

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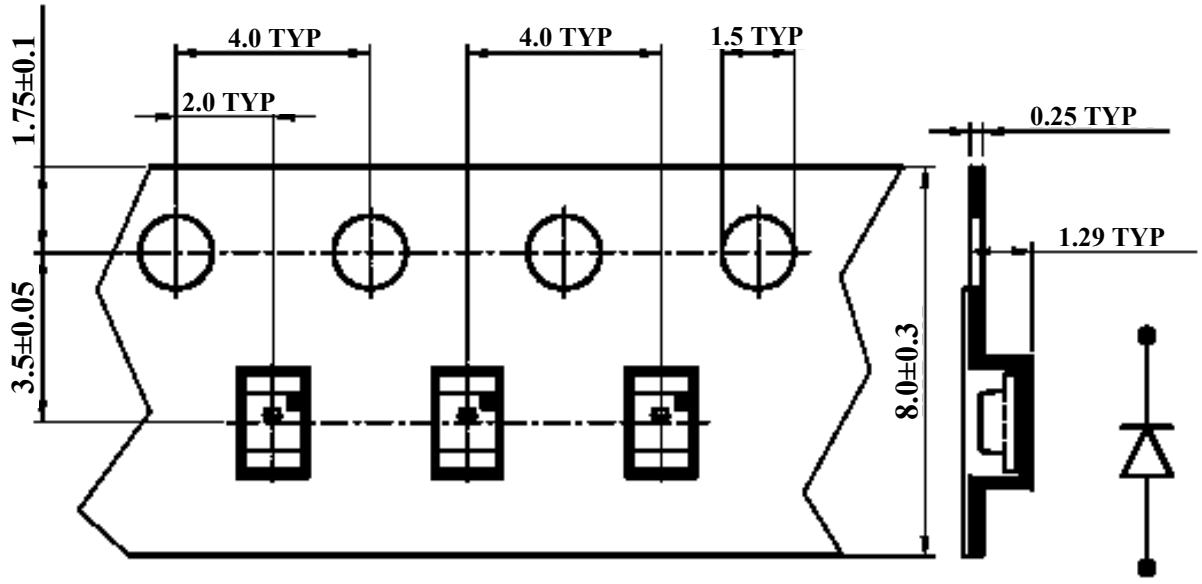
		SHEET 5 OF 9	

UNIT:MM

TOLERANCE: ±0.25

TYPE ⟶ **PACKAGE:2000 OR 1000PCS/REEL**

REEL"T":14mmTYP



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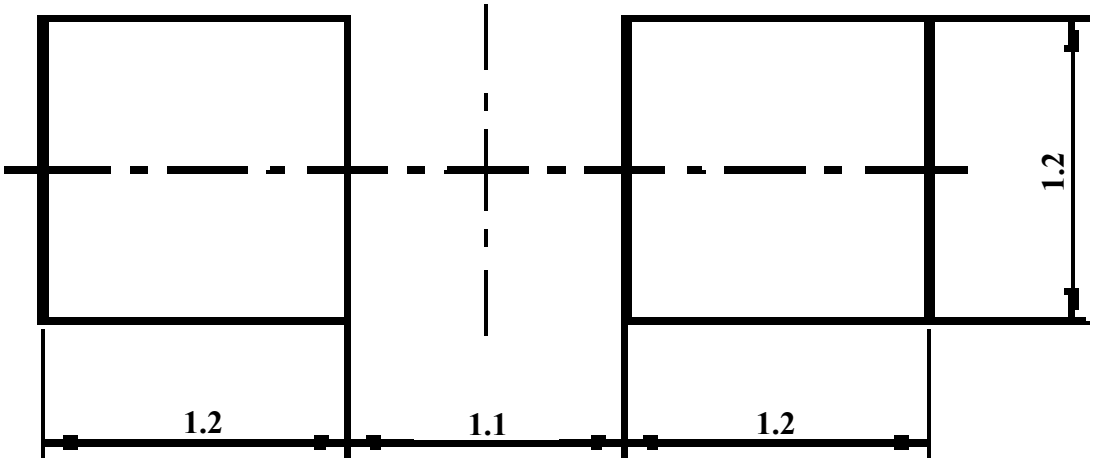
cosmo ELECTRONICS CORPORATION	SMD LED : KL-170YGX	NO. 61L20001	REV. 1
		SHEET 6 OF 9	

UNIT:MM

The following soldering patterns are recommended for reflow-soldering:

For reflow soldering



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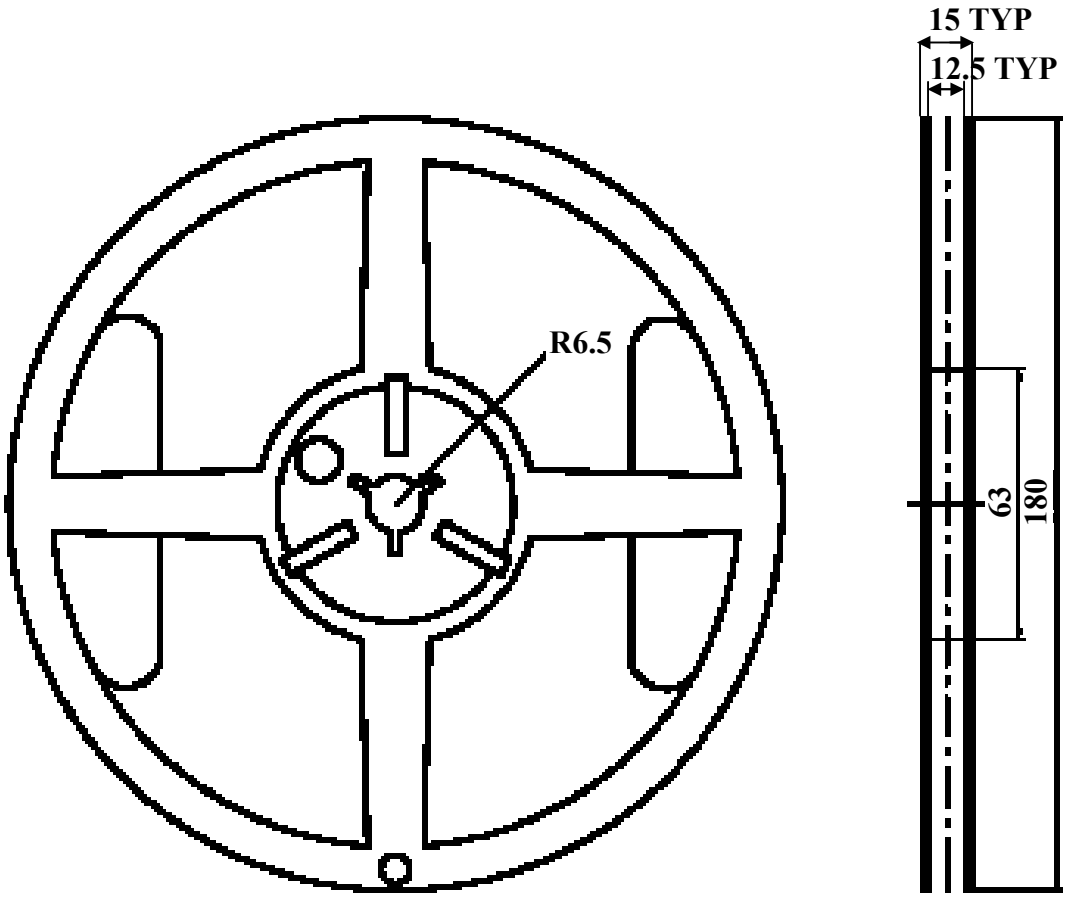
cosmo ELECTRONICS CORPORATION	SMD LED : KL-170YGX	NO. 61L20001	REV. 1
		SHEET 7 OF 9	

UNIT:MM

TOLERANCE: ±0.25



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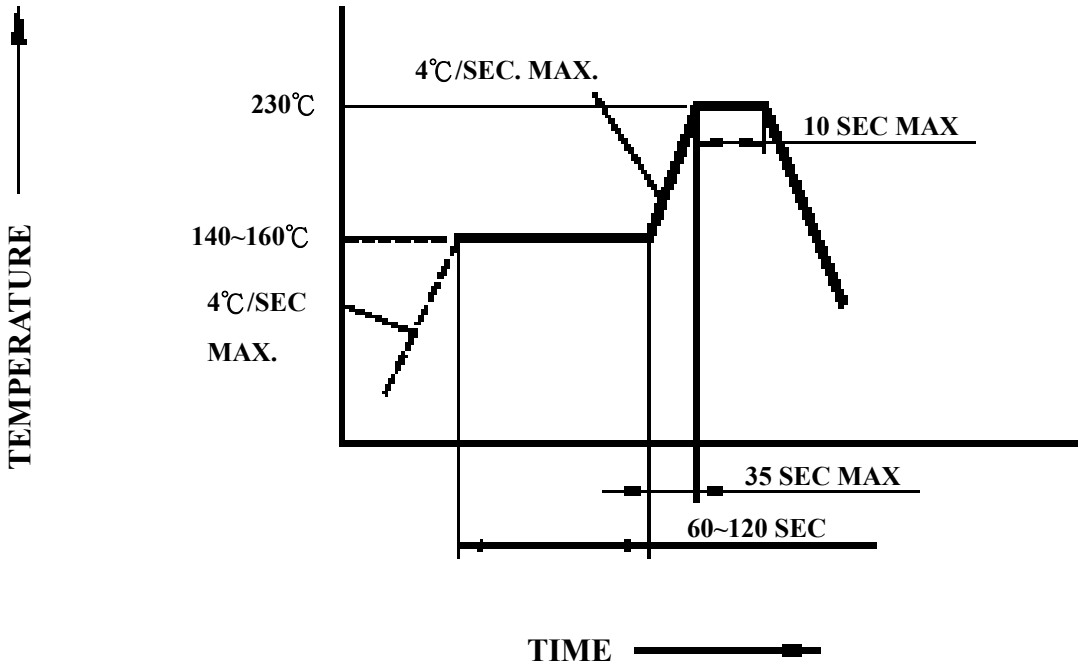
		SHEET 8 OF 9	

SOLDERING

SMT REFLOW SOLDERING INSTRUCTIONS



SOLDERING INSRTUCTIONS						
TYPES	DIP AND WAVE SOLDERING			IRON SOLDERING(WITH 1.5mm IRON TIP)		
	TEMPERATURE OF THE SOLDERING BATH	MAXLMUM SOLDERING TIME	DISTANCE FORM SOLDER JOINT TO CASE	TEMPERATURE OF SOLDERING IRON	MAXLMUM SOLDERING TIME	DISTANCE FROM SOLDER JOINT TO CASE
LEDS	≦260℃	3S	＞2mm	≦260℃	3S	＞2mm
	≦260℃	5S	＞4mm	≦260℃	5S	＞4mm
DISPLAYS	≦260℃	3S	＞2mm	≦260℃	3S	＞2mm

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		SHEET 9 OF 9	

SMD HANDLING AND APPLICATION PRECAUTIONS

STORAGE

(1.1)It is recommended to store the devices in accordance with the following conditions:

Humidity: 60%RH Max.

Temperature: 5℃~30℃ (41℉~86℉)

(1.2)Shelf life in sealed bag: 12 month at <5℃~30℃ and <30%RH.

After the package is opened, the products should be used within 72hrs.

Or they should be kept at ≦20%RH in zip -locked sealed bags.

DRY PACK AND BAKING

SMD LEDs are MOISTURE SENSITIVE devices. Avoid absorbing moisture at any time during transportation and/or storage. It is recommended to bake before soldering when the pack is unsealed after 72 hrs, or any suspicious moisture being found. Bake devices in accordance with the following conditions:

(a) 60±3℃ x (12~24hrs) and <5%RH, taped reel type

(b) 100±3℃ x (45min~1hr), loose packing type, or

(c) 130±3℃ x (15~30min), loose packing type

ELECTRIC STATIC DISCHARGE(ESD) PROTECTION

Materials with GaN, InGaN, AlInGaP are STATIC SENSITIVE devices. They will be packed in anti-static bags. ESD protection must be deliberatively observed from the initial design stage. The static -electric discharge may result in severe malfunction of the devices. In the events of manual working in process, make sure the devices are well protected from ESD at any time. Surge before and during handling products.